© Copyrig	al Composition I ght 2005. IPC, Banno nal and Pan-American	ckburn, Illinois. A	Il rights reserved ntions.	under both	This docume level parts, t	ent is a declaration e	ion of the su encompasses	ibstances v s all lower	vithin the manufactu level materials for w	rer listed it which the m	em. Note: anufactur	if the item is an as er has engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribu				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg Information				
Supplier Information													
Company name*	Company un	Company unique ID			Unique ID Authority				Respons	Response Date*			
nsemi									2024-10-06				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Repre	Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Numb	quester Item Number Mfr Iten		n Number Mfr Item Name			Effective Date	ve Date Version Manufacturing Site		V	Veight*	UOM	Unit Type	
		ADT7473ARQZ- REEL FAN CNTRL		R AND INT MON		2024-10-06		PI	PH1		7.0	mg	Each
Aanufacturing Proccess I	Information												
Terminal Plating / Grid Array Material Terminal B		Terminal Base	Alloy J-STD-020 MSL Rati		L Rating	Peak Proc	Peak Process Body Temperatu		are Max Time at Peak Tempe		ire Nun	nber of Reflow Cyc	eles
Matte Tin (Sn) - annealed C		CU Alloy	U Alloy 1			260 C		C	30 seco		seconds 3		
omments													
vel 1 - maximum time at peak	temperature during	soldering is 10-3	0 seconds										
or more information regarding	g material compositi	on please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.3	mg	Supplier	Silicon (Si)	7440-21-3		1.3	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame	31.11	mg	Supplier	Silver (Ag)	7440-22-4		0.4449	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0373	mg
			Supplier	Iron (Fe)	7439-89-6		0.7218	mg
			Supplier	Copper (Cu)	7440-50-8		29.8967	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	43.0	mg		Epoxy Phenol Resin	proprietary data		4.515	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.485	mg
Plating	0.86	mg	Supplier	Tin (Sn)	7440-31-5		0.86	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg